

4/12/06

Docket No. JCLA19185

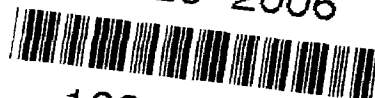
Form 1595  
1-31-92

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COVER SHEET

U.S. Department of Commerce  
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04-20-2006



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ase record the attached  
f.

1. Name of conveying party(ies):

Che-Chiang Chang  
Jian-Dai Pan

2. Name/address of receiving Party(ies):

Faraday Technology Corp.  
No. 5, Li-Hsin Rd. III, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.  
Add'l names of receiving parties Attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger ☐ Security Agreement ☐ Other ☐ Change of Name ☐ Reassignment

4. Date(s) of execution:

2006/03/01

5. Application number(s) or patent number(s):

**If this documents is being filed together with a new application, the execution date of the application is 2006/03/01.**

A. Patent Application No. (s)

B. Patent No. ( s)

Additional numbers attached ? ☐ Yes ☒ No

6. Name and address of party to whom  
Correspondence concerning document  
should be mailed:

J.C. Patents, Inc.  
4 Venture, Suite 250  
Irvine, CA 92618  
(949) 660-0761

7. Total No. of applications and patents involved:

ONE(1)

8. Total fee (37 CFR §3.41): \$40.00

☒ Enclosed ☐ Charge to Acct. No.

9. Total number of pages, including Cover sheet,  
attachments and document 3.

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10. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true  
and correct and any attached copy is a true copy of the original document.

Jiawei Huang

Name of Person Signing

Signature

Date

Registration No. 43,330

JC-FO-NEW0206

PATENT  
REEL: 017774 FRAME: 0817

## ASSIGNMENT

WHEREAS,

1. Che-Chiang Chang

2. Jian-Dai Pan

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **MEMORY BUILT IN SELF TEST CIRCUIT AND METHOD FOR  
GENERATING A HARDWARE CIRCUIT COMPRISING THE ROUTING  
BOXES THEREOF**

☐ Filed: Serial No.

☒ Executed concurrently with the execution of this instrument

WHEREAS, Faraday Technology Corp.

of No. 5, Li-Hsin Rd. III, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

## ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Che-Chiang Chang

Sole or First Joint Inventor: Che-Chiang Chang

Date: 2006/03/01

Signature: Jian-Dai Pan

Second Joint Inventor (if any): Jian-Dai Pan

Date: 2006/03/01